Resistive Inkjet Ink #3800 Series

Technical Datasheet

Product Description

An aqueous based, carbon nano-particle ink designed for both thermal and piezo inkjet printing systems. Secondary curing or processing is NOT required to achieve excellent adhesion and electrical conductivity on multiple, compatible substrates.

Features

- Applied via thermal or piezo printheads
- Cures at ambient temperature immediately after printing on coated media
- RoHs compliant
- Custom formulations

Ink Properties

- Viscosity
- Density
- Surface Energy
- Freeze/Thaw Stability

Up to 12 cps* @ 25 Celsius Brookfield LV #1 spindle, 60rpm 1.0 grams/ml 25 - 55 dynes/cm* @ 25 Celsius SITA Tensiometer Passes ASTM 2243

* Viscosity and Surface Energy levels available to match substrate and printhead requirements

Typical Printed Physical Properties

Print thickness (z-axis) 1 micron
Line width 50 micron lines and spaces (depending on drop size)
Color Black
Flex and Crease Resistance Excellent
Adhesion Excellent
Rub Resistance Excellent

Typical Printed Electrical Properties

- Sheet Resistance

Available ranges of 20,000 Ohms per square 10,000 Ohms per square 5,000 Ohms per square



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possibilities.

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